1200V 10A

Zero Recovery Silicon Carbide Schottky Diode

Vicroser

PRODUCT APPLICATIONS

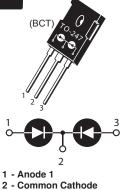
- Anti-Parallel Diode -Switchmode Power Supply -Inverters
- Power Factor Correction (PFC)

PRODUCT FEATURES

- Zero Recovery Times (t_{rr}) Popular TO-247 Package
- · Low Forward Voltage
- · Low Leakage Current

PRODUCT BENEFITS

- · Higher Reliability Systems
- · Minimizes or eliminates snubber



- Back of Case Cathode 3 - Anode 2

MAXIMUM RATINGS

All Ratings per Leg: T_{C} = 25°C unless otherwise specified.

Symbol	Characteristic / Test Conditions		Ratings	Unit	
V _R	Maximum D.C. Reverse Voltage				
V _{RRM}	Maximum Peak Repetitive Reverse Voltage		1200	Volts	
V _{RWM}	Maximum Working Peak Reverse Voltage				
	Maximum D.C. Forward Current	T _c = 25°C	36		
I _F		T _c = 135°C	10		
I _{FRM}	Repetitive Peak Forward Suge Current (T_j = 45°C, t_p = 10ms, Half Sine Wave)		50	Amps	
I _{FSM}	Non-Repetitive Forward Surge Current ($T_J = 25^{\circ}C$, $t_p = 10$ ms, Half Sine)		110		
P _{tot}	Power Dissipation	T _c = 25°C	125	W	
		T _c = 110°C	45		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to 150	- °C	
TL	Lead Temperature for 10 Seconds		300		

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		Min	Тур	Max	Unit
V _F	Forward Voltage	I _F = 10A T _J = 25°C		1.5	1.8	Volts
		I _F = 10A, T _J = 150°C		2.1		
I _{RM}	Maximum Reverse Leakage Current	V _R = 1200V T _J = 25°C			200	μA
		V _R = 1200V, T _J = 150°C			1000	
Q _c	Total Capactive Charge V _R = 800V, I _F = 10A, di/dt = -100A/ μ s, T _J = 25°C			30		nC
C _T	Junction Capacitance $V_{R} = 0V$, $T_{J} = 25^{\circ}C$, f = 1MHz			600		pF
	Junction Capacitance V_{R} = 200V, T_{J} = 25°C, f = 1MHz			71		
	unction Capacitance V_{R} = 400V, T_{J} = 25°C, f = 1MHz			52		

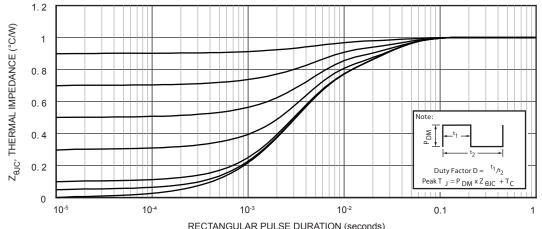
THERMAL AND MECHANICAL CHARACTERISTICS

APT10SCD120BCT

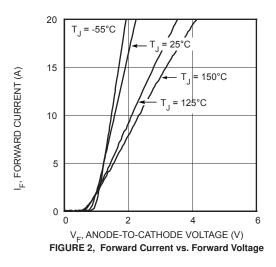
Symbol	Characteristic / Test Conditions	Min	Тур	Мах	Unit
R _{ejc}	Junction-to-Case Thermal Resistance			1.0	°C/W
W _T	Package Weight		0.22		oz
			5.9		g
Torque	Maximum Mounting Torque			10	lb∙in
				1.1	N∙m

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TYPICAL PERFORMANCE CURVES







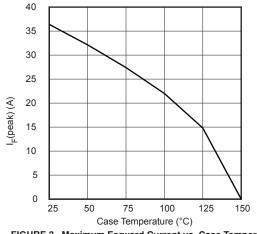
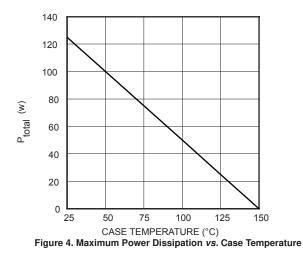
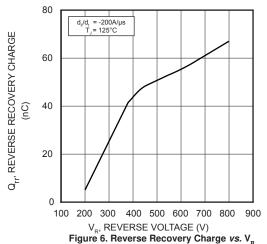
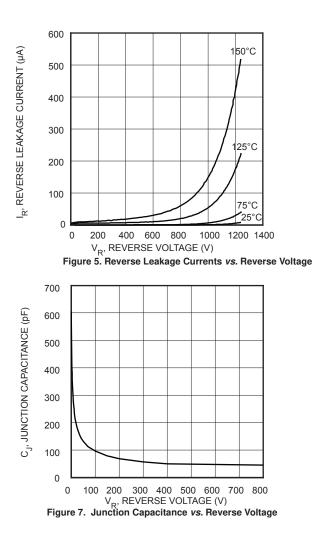


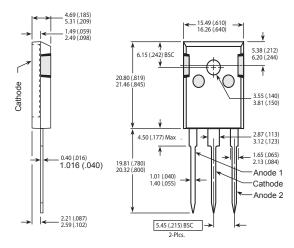
FIGURE 3, Maximum Forward Current vs. Case Temperature











Dimensions in Millimeters and (Inches)

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